

CONTACT DATA

Accepts 0.20mm - 0.33mm Diameter pins 3-finger 37/25 gram, Initial insertion force (with 0.254mm/0.203mm dia. pin) 30/22 gram, normal force (with 0.254mm/0.203mm dia. pin)

20/17 gram, extraction force (with 0.254mm0.203mm dia. pin)

- Pins: material- Brass Alloy 360 1/2 hard; finish-<br/>0.25μm [10μ"] Au over 1.27μm [50μ"] Ni (min.).

Contacts: Beryllium Copper Alloy172, HT; Finish-0.25µm [10µ"] Au over 1.27µm [50µ"] Ni (min.).

4 Solder Balls: See table above

## Description: Giga-snaP BGA SMT Foot

352 position (1.0mm pitch) gold plated female receptacle pins to SMT solder balls (BGA type). Pin asignment 1:1.

<u>Tolerances:</u> diameters  $\pm 0.03$ mm [ $\pm 0.001$ "], PCB perimeters  $\pm 0.18$ mm [ $\pm 0.007$ "], PCB thicknesses  $\pm 0.18$ mm [ $\pm 0.007$ "], pitches (from true position)  $\pm 0.08$ mm [ $\pm 0.003$ "], all other tolerances  $\pm 0.13$ mm [ $\pm 0.005$ "] unless stated otherwise. Materials and specifications are subject to change without notice.

	SF-BGA352E-B-42 Drawing	Status: Released	Scale	: 4:1	Rev: A
R	© 2010 IRONWOOD ELECTRONICS, INC. Tele: (800) 404-0204 www.ironwoodelectronics.com	Drawing: V. Panavala		Date: 10/8/10	
		File: SF-BGA352E-B-42 Dwg	ile: SF-BGA352E-B-42 Dwg		Modified: